

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
LI QIAN	07/28/2010
LI FAN	07/28/2010
LIANG LIU	07/28/2010
CHEN FENG	07/28/2010
YU-QUAN WANG	07/28/2010

RECEIVING PARTY DATA

Name:	Beijing FUNATE Innovation Technology Co., LTD.
Street Address:	B1115, RD Plaza, Tsinghua Science Park, Shuangqing Road, Haidian District
City:	Beijing
State/Country:	CHINA

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12848315

CORRESPONDENCE DATA

Fax Number: (909)978-6366
Correspondence will be sent via US Mail when the fax attempt is unsuccessful.
 Phone: 9099786584
 Email: Clifford.Chi@foxconn.com
 Correspondent Name: Clifford O. Chi
 Address Line 1: 288 South Mayo Avenue
 Address Line 4: City of Industry, CALIFORNIA 91789

ATTORNEY DOCKET NUMBER:	US31020
NAME OF SUBMITTER:	Clifford O. Chi

Total Attachments: 2
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**PATENT
 REEL: 024773 FRAME: 0044**

ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

- 1. LI QIAN , residing at Beijing, China
- 2. LI FAN , residing at Beijing, China
- 3. LIANG LIU , residing at Beijing, China
- 4. CHEN FENG , residing at Beijing, China
- 5. YU-QUAN WANG , residing at Beijing, China
- 6. _____ , residing at _____
- 7. _____ , residing at _____
- 8. _____ , residing at _____

hereby sell(s), assign(s) and transfer(s) unto: **BEIJING FUNATE INNOVATION TECHNOLOGY CO., LTD.** having a principal place of business at **B1115, R&D Plaza, Tsinghua Science Park, Shuangqing Road, Haidian District, Beijing, P.R.C.** hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **TRANSMISSION ELECTRON MICROSCOPE MICRO-GRID** for which the undersigned

[] previously executed --- Ser. No. _____ and filing date of _____
[x] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1.	<u>Li Qian</u> LI QIAN	<u>Jul. 28, 2010</u> Date
2.	<u>Lifan</u> LIFAN	<u>Jul. 28, 2010</u> Date
3.	<u>Liang Liu</u> LIANG LIU	<u>Jul 28, 2010</u> Date
4.	<u>Chen Feng</u> CHEN FENG	<u>Jul. 28, 2010</u> Date
5.	<u>Yu-Quan Wang</u> YU-QUAN WANG	<u>Jul, 28, 2010</u> Date
6.	_____	_____ Date
7.	_____	_____ Date
8.	_____	_____ Date
9.	_____	_____ Date